AUTOMATED INTEGRATION OF SIMULINK MODELS INTO VIRTUAL PLATFORMS

ANDREAS MAUDERER ROBERT BOSCH GMBH – AUTOMOTIVE ELECTRONICS

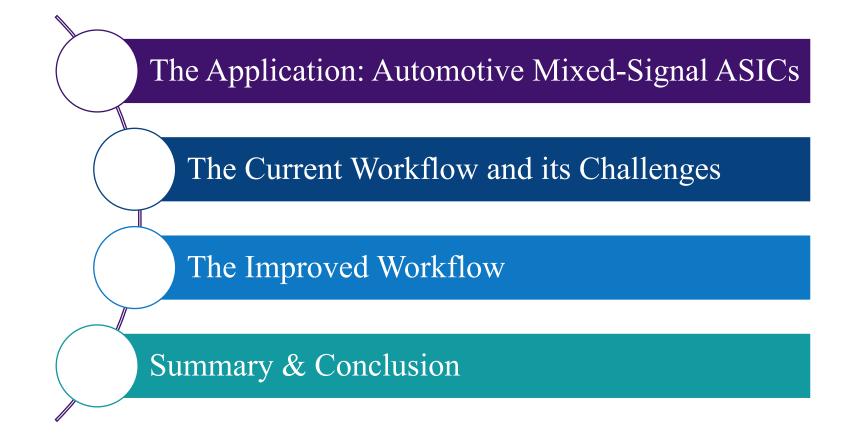
ALEXANDER SCHREIBER THE MATHWORKS GMBH

MATLAB EXPO JUNE 27TH, 2017 MUNICH, GERMANY



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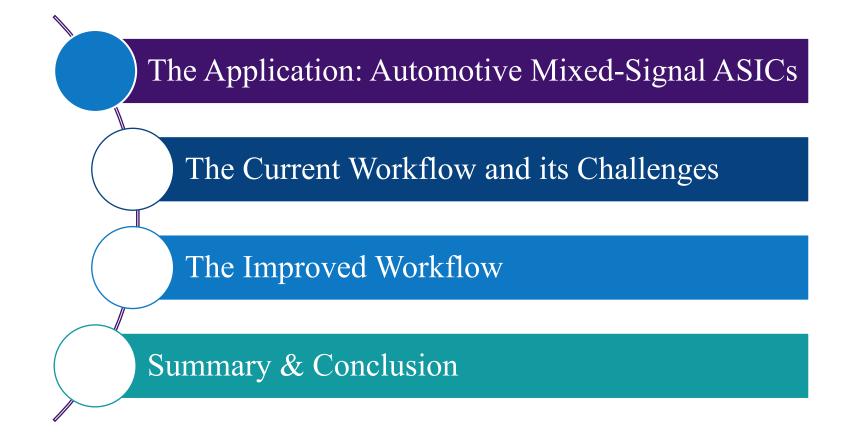
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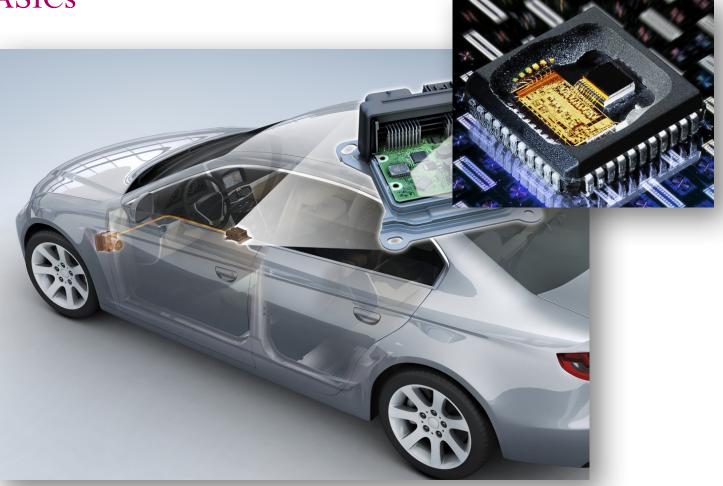


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Integration of Simulink Models into Virtual Platforms Automotive Mixed-Signal ASICs

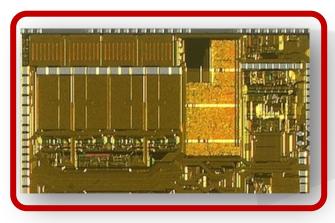
- Bosch accelerates progress of automotive technology with continued innovations like ESP or autonomous driving solutions
- Integral part for these solutions are automotive sensors
- Example: Inertial sensor system for ESP



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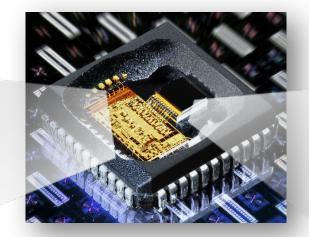


Integration of Simulink Models into Virtual Platforms Automotive Mixed-Signal ASICs

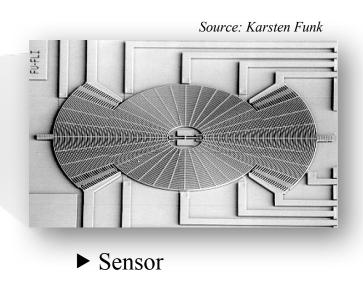


- ► Heterogeneous SoC:
 - ► Analog Hardware
 - Digital Non-Programmable Hardware
 - ► Processors

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► System-in-Package (SiP)



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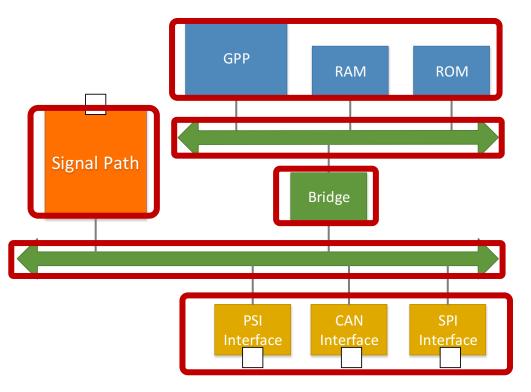
Integration of Simulink Models into Virtual Platforms Sensor ASIC – Architecture Example

- Signal path for sensor signal processing
- General Purpose Processor (GPP) subsystem for
 - ► safety monitoring
 - communication protocols
 - ► etc.

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Several interfaces

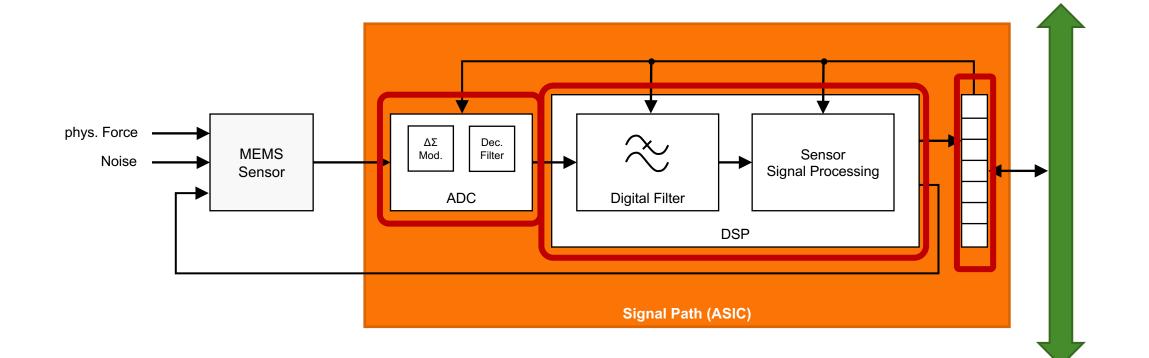
► On-Chip Architecture



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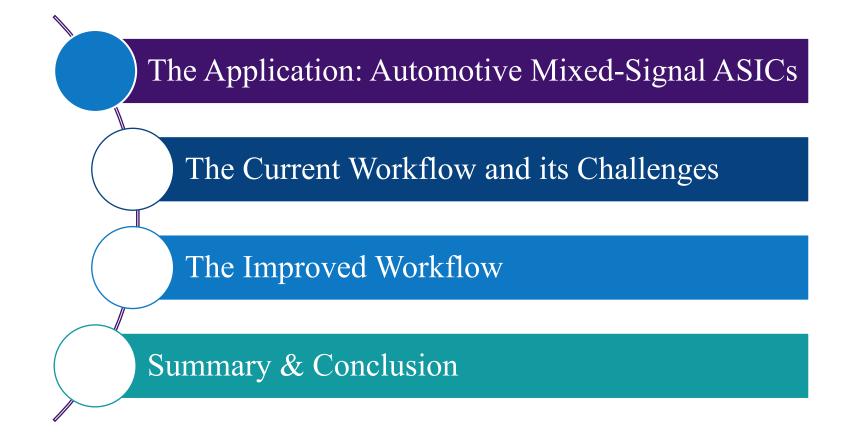


Integration of Simulink Models into Virtual Platforms Sensor ASIC – Signal Path Example



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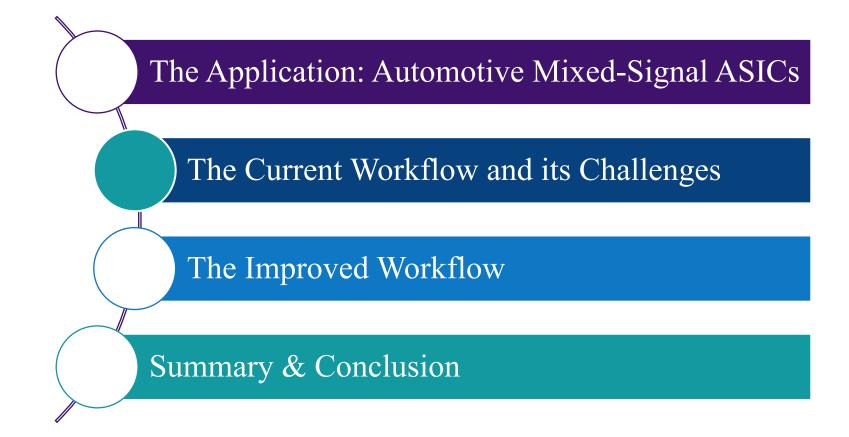




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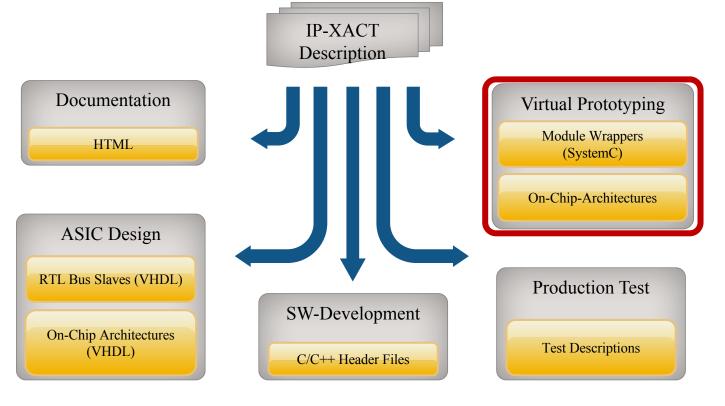


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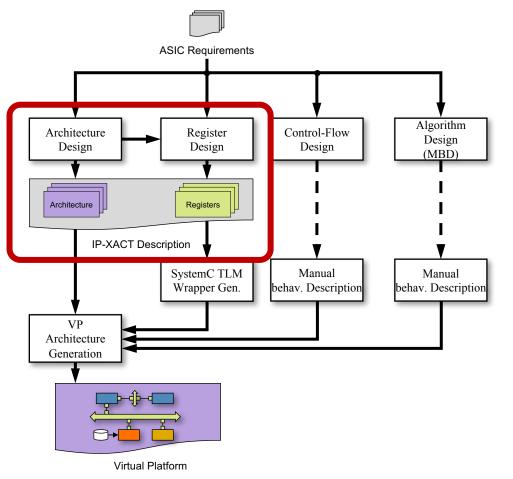
Integration of Simulink Models into Virtual Platforms Current Workflow - IP-XACT-Centric Tool Environment

- ► IP-XACT description as single source
- Generation of various design, test and documentation outputs
- Ensures consistency throughout the whole design flow





Integration of Simulink Models into Virtual Platforms Current Workflow - IP-XACT-Centric VP Generation



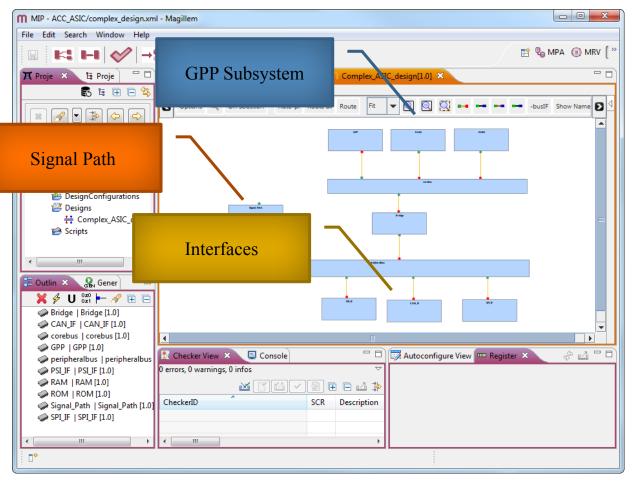
- Description of architecture and register interfaces in IP-XACT
- Automated generation of VP architectures and TLM register interfaces
- Signal processing algorithm design using Model-Based Design
- Manual behavioural description of controland signal-flow oriented designs

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Integration of Simulink Models into Virtual Platforms Architecture Design - Magillem[®] IP-XACT Packager (MIP)

- Design of On-Chip Architecture in Magillem[®] IP-XACT Packager
- Saved as IP-XACT Design description



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Integration of Simulink Models into Virtual Platforms Register Interface Design - Magillem[®] Register View (MRV)

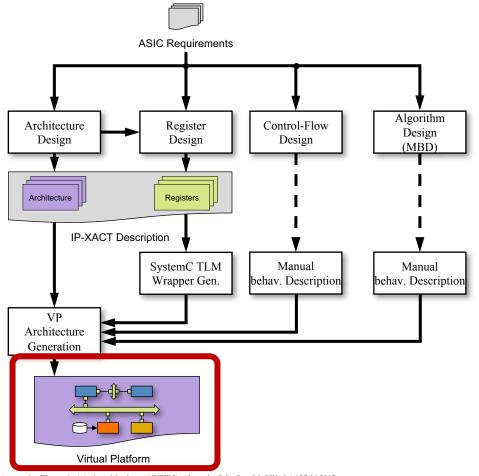
- Design of register interfaces in Magillem[®] Register View
- Saved as IP-XACT Component description

MRV - ACC_ASIC/Signal_Path.xml - Magillem								
File Edit Search Model Editor Window Help								
					😭 🌯 MPA 💽 MRV : »			
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ACC_ASIC	Name*	Absolute Address	Access Type	Address Offset*				
AbstractionDefinitions	SensorInterface_AdressBlock	0x0 (computed)		0x00000000 (auto				
Abstractors	IIII ACC_1_In	0x0 (computed)	write-only	0x0				
🕮 BusDefinitions	MWMapInput							
🔺 🔛 Components	ACC_2_In	0x8 (computed)	write-only	0x8				
🧼 Bridge [1.0] 🗏	MWMapInput							
CAN_IF [1.0]								
i corebus [1.0]								
🧼 GPP [1.0]								
i peripheralbus [1.0]								
PSI_IF [1.0]								
AAM [1.0]								
ROM [1.0]								
🧼 Signal_Path [1.0] 👻								
۰ III +	Memory Map Tree Table							
🔚 Outline 🗙 🚱 Generators 📃 🗆	🚥 Register 🗙 📮 Console 🔝	Checker View			🕹 🗖 🗖			
🔚 Signal_Path 🔺				ACC_1_In	ACC_1_In Description			
MWVendor								
MWVersion	31 23	15	7	<u> </u>				
MWModel				С ¹	Bitfield Description			
MWBlock								
memorymap_sensor								
SensorInterface_AdressBlock								
ACC_1_In	1				•			
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Integration of Simulink Models into Virtual Platforms Current Workflow - IP-XACT-Centric VP Generation



 Automated generation of VP architectures and TLM register interfaces

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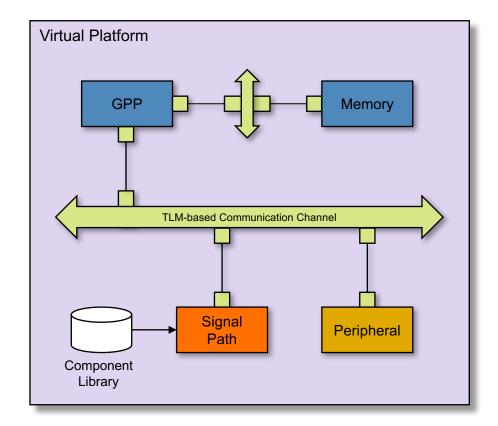


Integration of Simulink Models into Virtual Platforms Virtual Platforms (VP)

- ► SoC architecture-centric
- Highspeed pre-silicon development environment
- Abstracting communication interfaces through Transaction Level Modelling (TLM)

► Benefits

- SoC concept validation and architectural exploration
- ► Concurrent SW and HW development
- ► Validation of HW/SW interfaces
- ► Optimization of SW

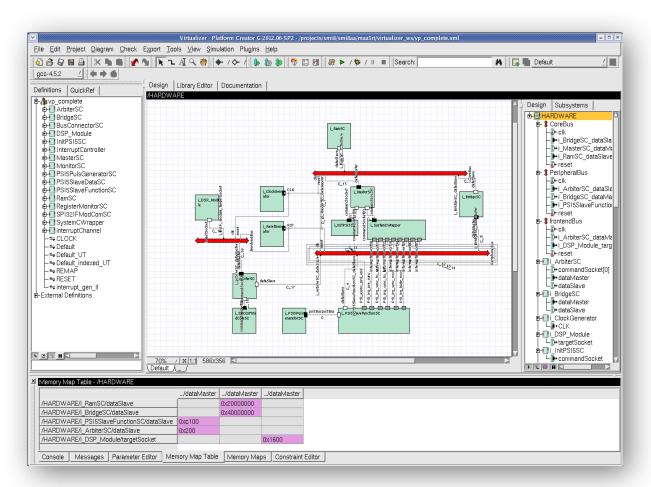


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Integration of Simulink Models into Virtual Platforms System Simulation and SW Dev. in Synopsys[®] VirtualizerTM

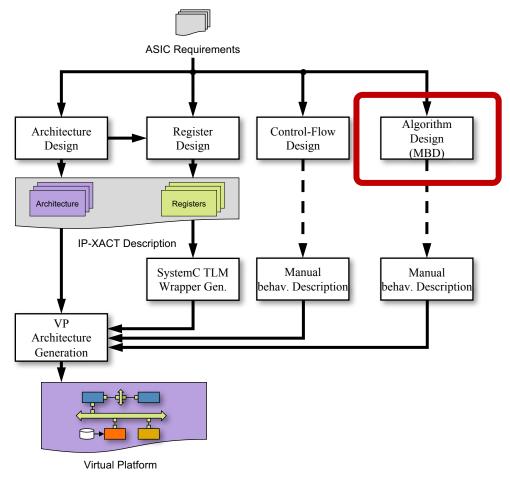
- Tool for construction and simulation of Virtual Prototypes
- ► Large module library
- ► Comprehensive debugging capabilities
- Export of development kits for SW development



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Integration of Simulink Models into Virtual Platforms Current Workflow - IP-XACT-Centric VP Generation

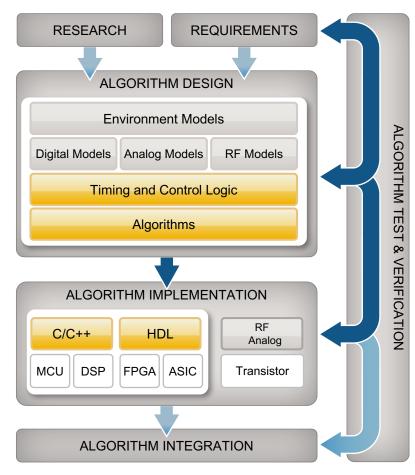


 Signal processing algorithm design using Model-Based Design

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Integration of Simulink Models into Virtual Platforms Model-Based Design (MBD)



- ► Algorithm-centric
- ► Signal flow-oriented multi-domain simulation
 - Differential equation, transfer function, physical network level
 - ► Time-continuous, time-discrete
 - ► Value-continuous, value-discrete
- ► Benefits
 - Mathematical algorithm design
 - Early verification of its functional correctness and performance in its environment
 - ► Implementation through automatic code generation

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Integration of Simulink Models into Virtual Platforms Example: Lowpass Filter Design with DSP System Toolbox[™]

Specification:

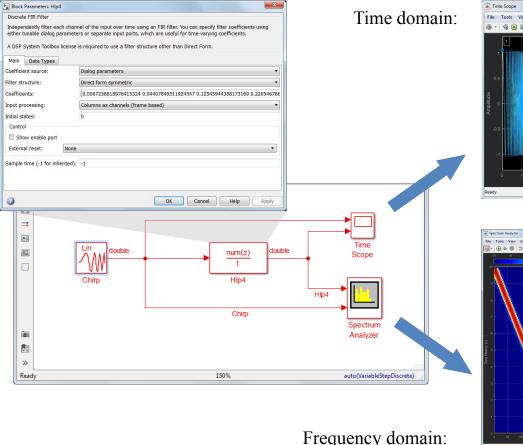
- ► Filter response: FIR
- Design Method: Equiripple
- ► 6dB-cutoff frequency: (.25
- ► Stopband attenuation: 6) dB
- ► Passband ripple: 1dB

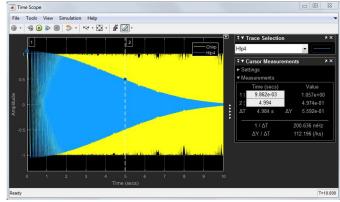
A Lowpass Design	
Lowpass Design	
Design a lowpass filter.	
Filter output variable name: Hlp4 View Filter Response	e
Main Data Types Code Generation	
-Filter specifications	
Impulse response: FIR 🔹	
Order mode: Specity	
Order: 8	
Filter type: Single-rate	
Frequency specifications	
Frequency constraints: Cutoff (6dB) frequency	
Frequency constrained (out of 1)	
Cutoff (6dB) frequency: .25	
Magnitude specifications	4
Magnitude constraints: Passband ripple and stopband attenuation	
Passband ripple: 1 Stopband attenuation: 60	
Algorithm	
Design method: Equiripple	
Pesigir options	
Filter implementation	
Structure: Direct-form symmetric FIR	
Use a System object to implement filter	
	4
OK Cancel Help Apply	

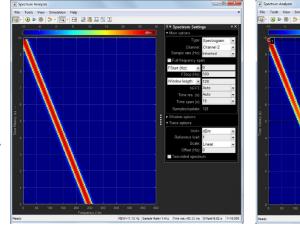
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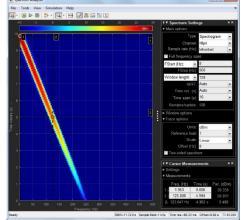


Integration of Simulink Models into Virtual Platforms Signal-Flow-based Simulation with Simulink[®]





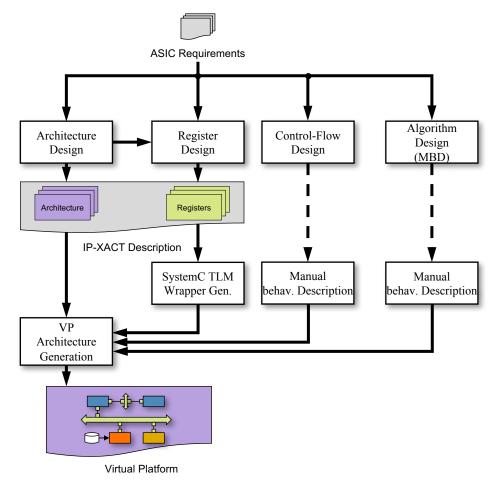




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Integration of Simulink Models into Virtual Platforms Gap Analysis

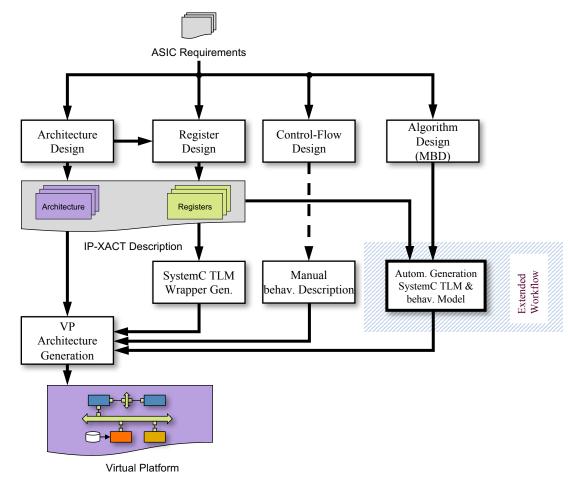


- ► Benefits of Model-Based Design
 - Verified algorithm meeting signal processing characteristics
- ► Workflow Gap
 - Manual behavioural description of algorithm
 - Manual integration into SystemC TLM wrapper
- ► Potential Issue
 - Mismatch between manual behavioural description and implementation

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Integration of Simulink Models into Virtual Platforms Gap Analysis



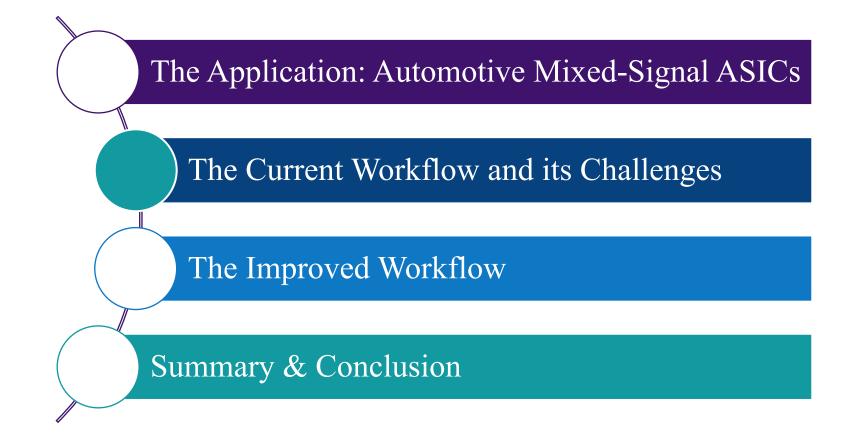
Solution:

- Automatic generation of SystemC TLM component
 - ► Behavioural algorithmic model
 - ► Integration in SystemC TLM wrapper
- ► IP-XACT register definition as input

► Support of SCML register

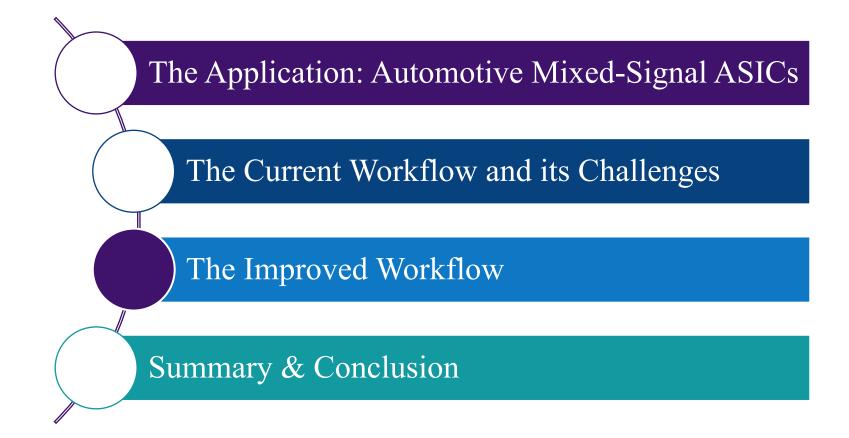
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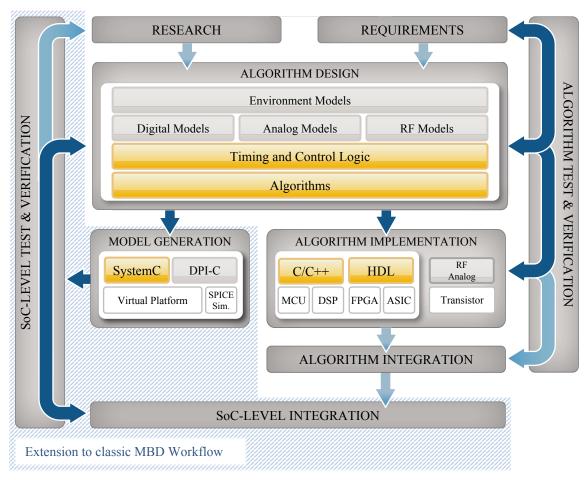




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Integration of Simulink Models into Virtual Platforms Algorithm Design & Model Generation

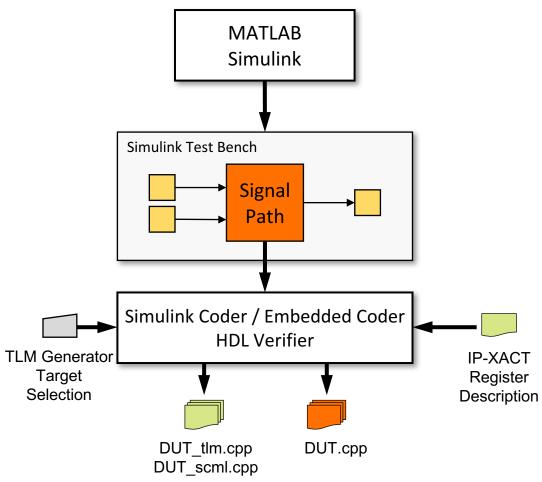


- Extended Model-Based Design Workflow
 - Model Generation
- Additional code generation targets
 - ► Virtual platforms (e.g. SystemC TLM 2.0)
 - Verification environments (e.g. SystemVerilog DPI-C)
- ► Benefits
 - ► Integrated, automated workflow
 - ► Functional equivalence between ...
 - Algorithm design
 - Virtual Platform model
 - Algorithm implementation

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Integration of Simulink Models into Virtual Platforms Algorithm Design & Model Generation

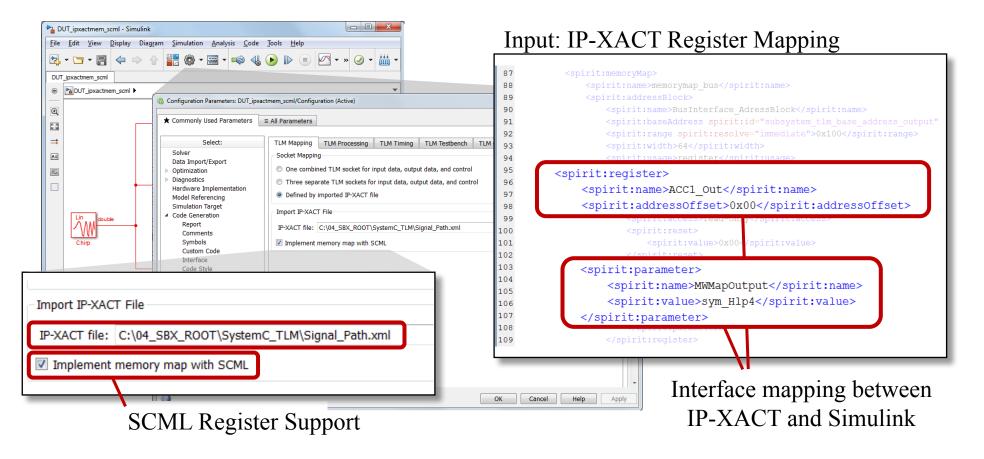


- ► Algorithm Design
 - Mathematical representation
 - Multi-domain simulation environment
 - Early algorithm verification within its environment
- ► Model Generation
 - ► Automatic code generation (SystemC TLM)
 - ► IP-XACT register description as input
 - Behavioural description integrated in SystemC TLM wrapper
 - Self-testing SystemC TLM testbench
 - ► IP-XACT register description as output

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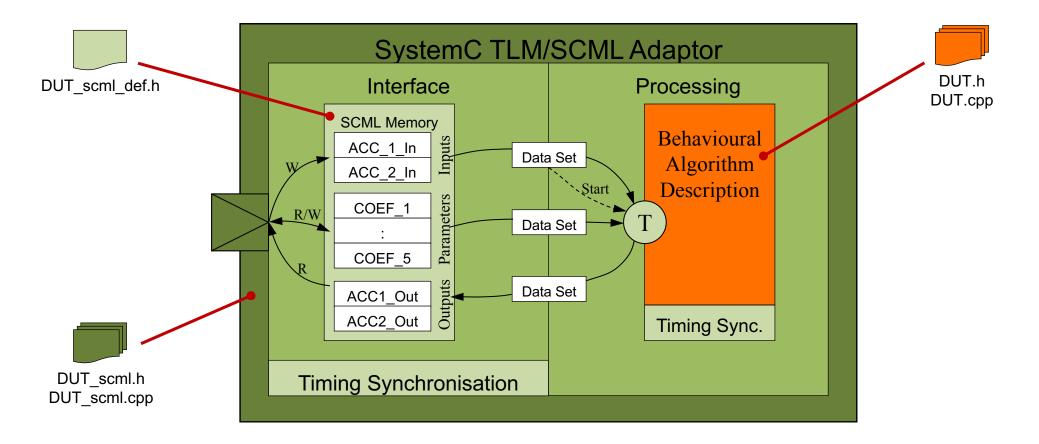
Integration of Simulink Models into Virtual Platforms Model Generation - IP-XACT Register Mapping (I/O, Parameters)



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Integration of Simulink Models into Virtual Platforms Model Generation - SystemC TLM/SCML Adaptor Architecture



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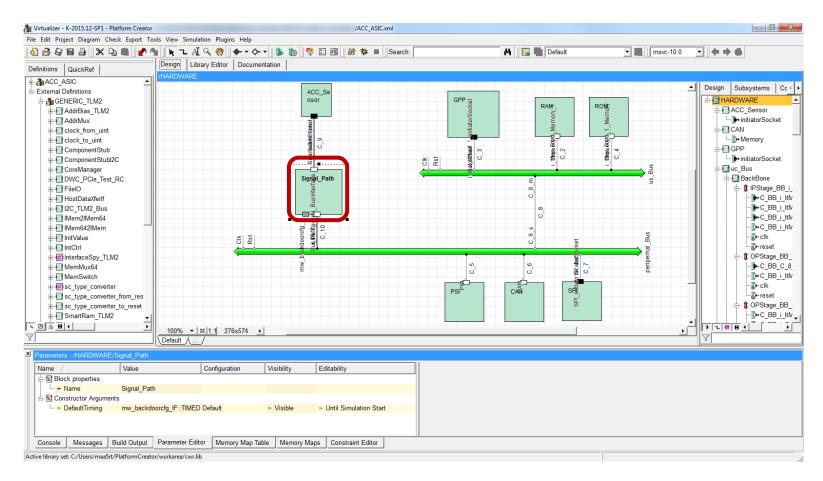
Integration of Simulink Models into Virtual Platforms Integration and Simulation - Manual Import of SystemC Module

Import SystemC Modules			
Files Include Paths	•	3 1	
	Simulink/DUT_VP/I	DUT_scml/src/DUT_scml.cpp	
	A SystemC Build Configuration		
Add	FromSource <default></default>	Setting Add	
Import all modules	— Path Environment Variables — Makefile Includes	A SystemC Build Configuration	२ <mark>×</mark>
C Import modules:	Dynamic Load Primitive Channel Payload Headers	FromSource <default></default>	1
Generate TLM proto	Source Files	Setting Compiler Compiler Compiler C/PROGRA~1/MATLAB/R2016a/bin/win64 *	Add Remove
Reset	Libraries Template Fallback Libraries Compile Flags Link Flags	Primitive Channel Payload Headers Infrastructure parameters Source Files Header Files Include Paths	Move Up Move Down
	Oynamic Library Search Paths Outline Scripts Unevaluated Parameter Files	Library Paths Library Paths Libraries Template Fallback Libraries Compile Flags Link Flags	
	Active library set: C:/Users/maabit/PlatformCreator/worka	Elin Flags Dynamic Library Search Paths Build Scripts Unevaluated Parameter Files	
		Add Clone Remove Rename Make default	OK Cancel

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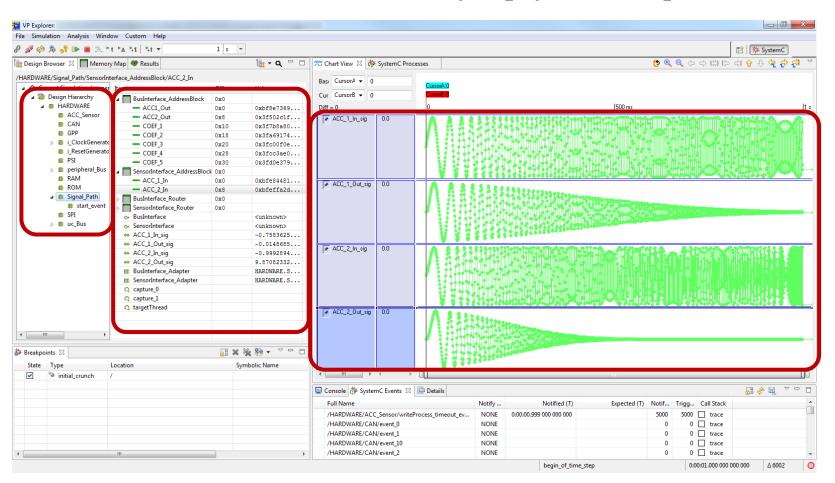
Integration of Simulink Models into Virtual Platforms Integration and Simulation - SystemC Module in Synopsys[®] Virtualizer[™]



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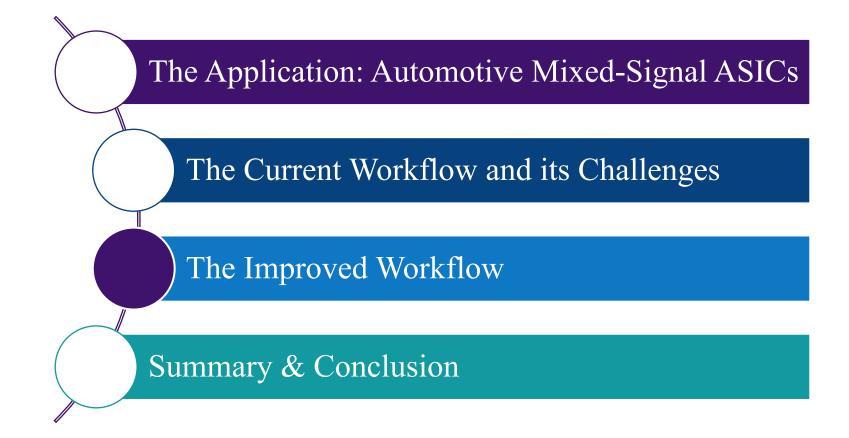


Integration of Simulink Models into Virtual Platforms Integration and Simulation – Simulation in Synopsys[®] VPExplorer



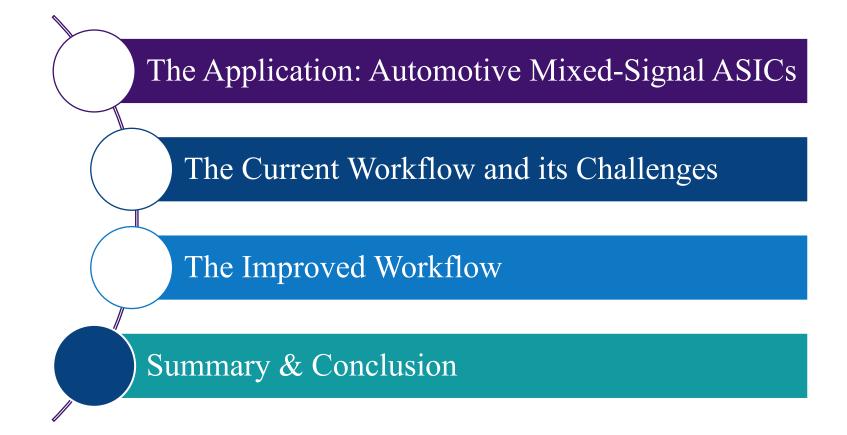
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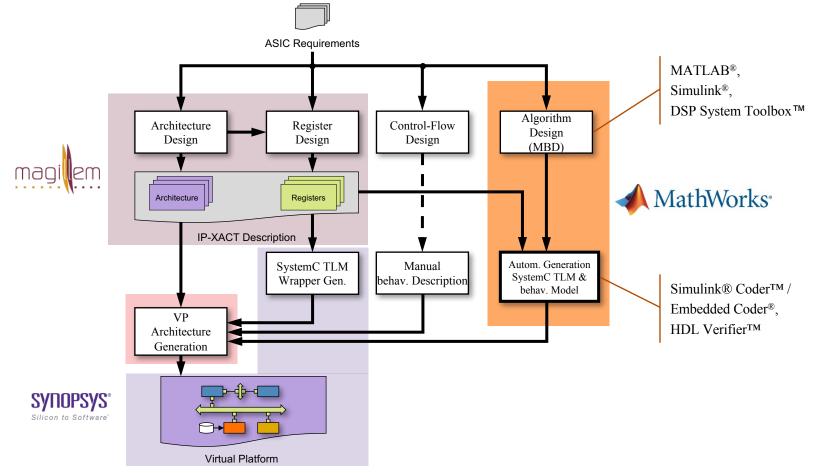




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Integration of Simulink Models into Virtual Platforms Summary – Bosch Workflow



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Integration of Simulink Models into Virtual Platforms Summary & Conclusion

► Developed method:

Automated integration of Simulink signal processing behaviour modules into Virtual Platforms

- ► Generated artefacts:
 - ► Functional core
 - SystemC TLM2.0 Wrapper with SCML registers based on IP-XACT description
 - Code connecting wrapper and functional core
- ► Benefits:
 - Increase of efficiency for integration signal processing behaviour into VPs
 - Earlier availability of functional VPs of signal processing ASICs
 - ► Inherent consistency between Simulink model and VP

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